

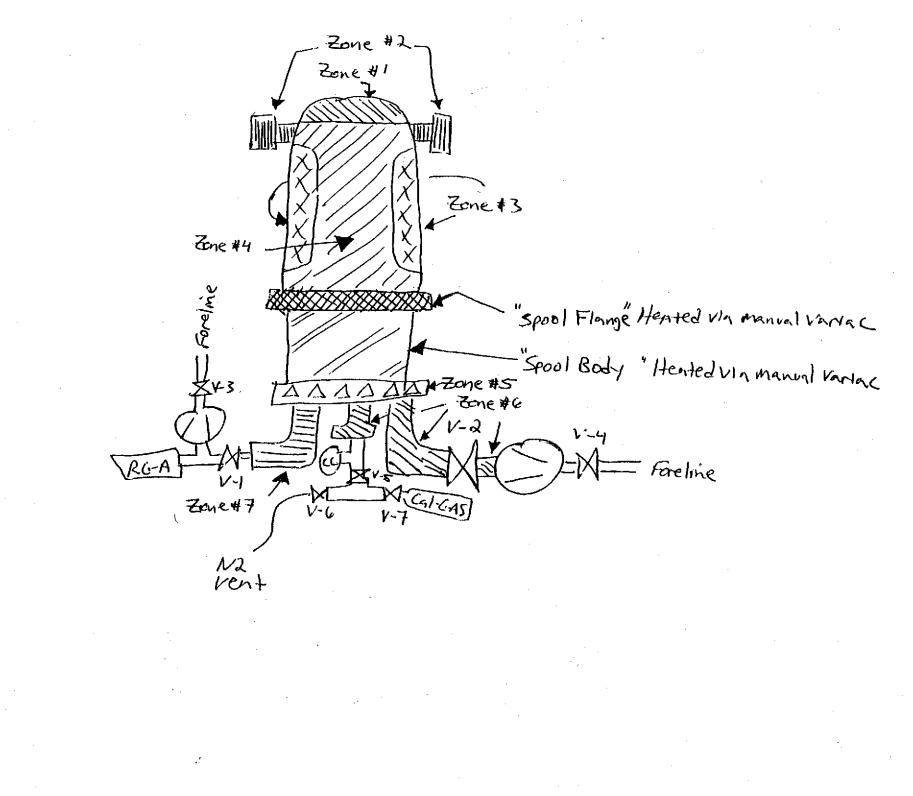
Summary of LHO Vacuum Bake Oven A RGA Data Generation

The individual parts which comprise a "load" are cleaned as per LIGO-E960022 or as allowed by waiver(s) and loaded into the bake oven. The oven is then pumped down through the main pump "arm" (through V-2, RGA arm is valved off at this point). A heating profile is programmed and baking of the system begins. A typical "heating profile" consists of ramping up to material type soak temperature, soaking for approximately 48 hours, ramping down to approximately 70C, soaking and then ramping down to near room temperature. While soaking at 70C, an RGA background scan is taken. V-1 is then opened and V-2 closed. Enough time is allowed for the system to come into pressure equilibrium and then an elevated load temperature RGA scan is taken. V-1 is then closed and V-2 opened. Following this elevated temperature scan, the load is ramped down to near room temperature and the baking portion of the process is complete. Throughout the baking, temperature data is taken to verify the actual temperatures in the various "heat zones" of the bake oven system.

Once at near room temperature, another RGA background (V-1 closed) scan is taken. Next, V-1 and the cal-gas are opened and V-2 closed. After a 30 minute pressure equilibration time, a "calibration" scan is taken. The calculated pressure of Argon (constituent of the "mixed" calibration gas) is determined using the leak rate of Argon and the pump speed of the RGA arm port as seen by the oven chamber and compared (ratio) to the maximum amp value measured for Argon in the calibration scan. This "torr/amp" ratio becomes the Calibration Factor for the given load, converting measured current to pressure.

Finally, the cal-gas is valved out and enough time is allotted to allow all traces of it to be pumped away. A "post-bake" scan is then taken. Approval of the post-bake scan is a collective "pass/fail" determination made by either Dennis Coyne (CalTech) or Stan Whitcomb (CalTech). The data collected during the "elevated temperature scan" is entered into a spreadsheet which then calculates what the outgassing rates of AMUs 41, 43, 53, 55 and 57 ought to be at room temperature. These calculations are used to determine the room temperature outgassing rates when the signals are below the RGA's sensitivity (noise floor).

Refer to the LHO Vacuum Bake Oven A logbook for the actual ordered events of the load # of interest.

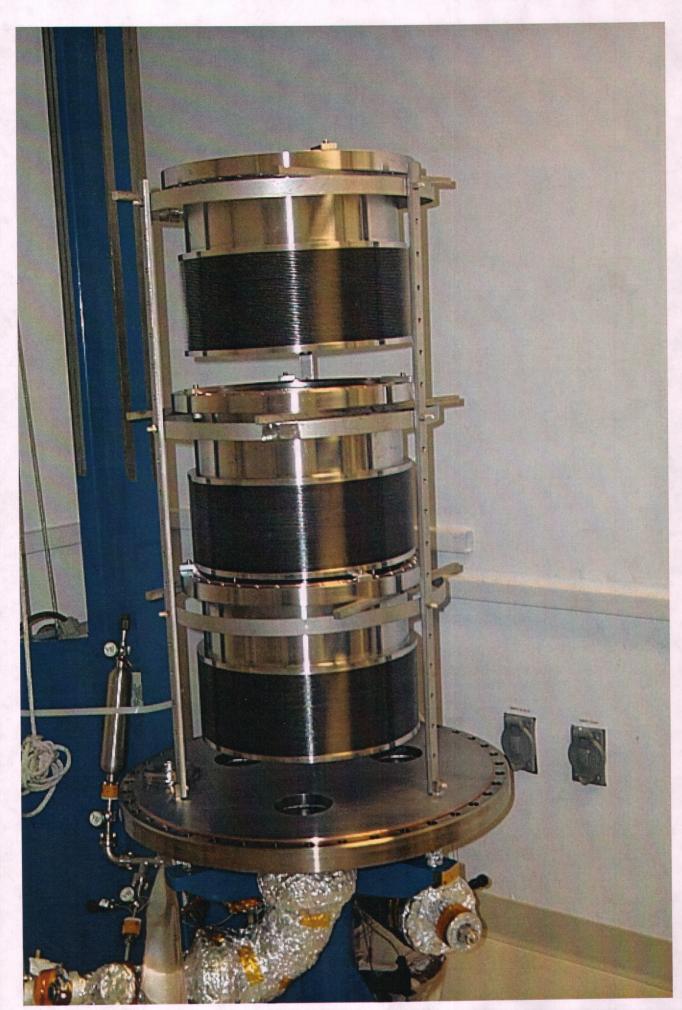


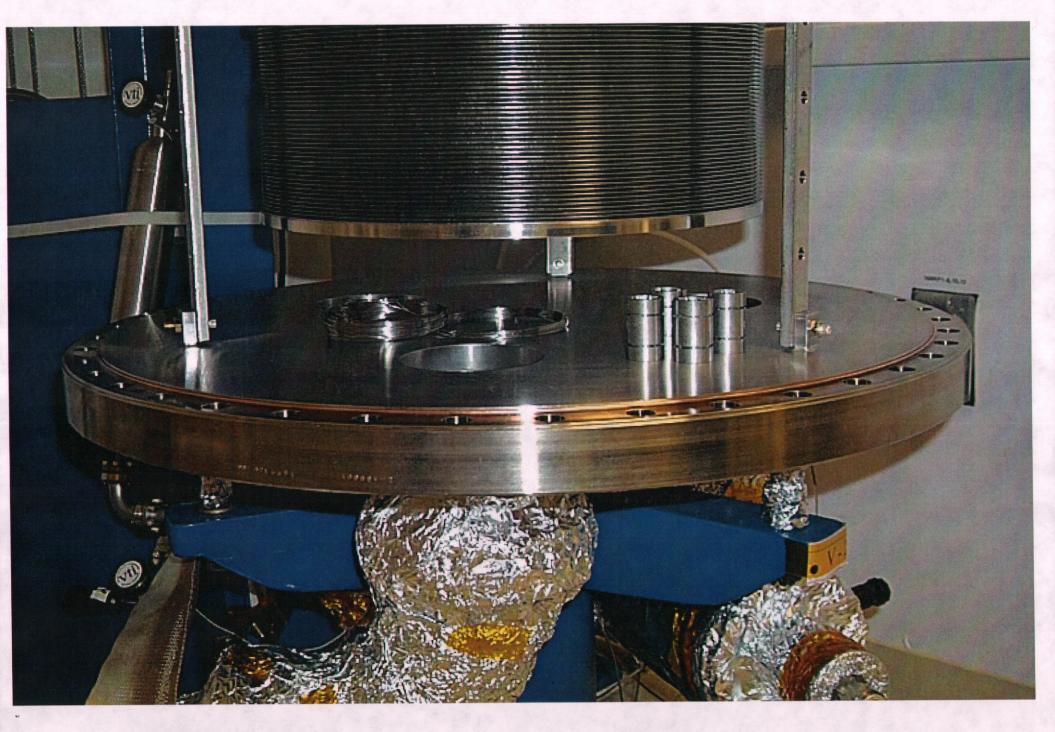
LHO VACUUM BAKE OVEN A: CONTENTS LOAD #53

1

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B.S.C. BELLOW SERIAL NUMBER-051 B.S.C. BELLOW SERIAL NUMBER-057 B.S.C. BELLOW SERIAL NUMBER-061 SAFETY WIRE SERIAL NUMBER N/A E.T.M. TELESCOPE PIVOT HINGES SERIAL NUMBER







DCC Number:	E99179-00-X
Date Prepared:	8/24/99

Account Originator **Cognizant Engineer** Ext./Phone# Project Number Betsy Weaver Janeen Hazel-Romie (626) 395-8445 SUS 5F518 **Dwg/Part Number** Rev **Part Description** Serial Number Qty Stainless Steel Wire for tying OSEM cables to the LOS ~30 feet structures Used In (next higher assembly): Vendor Name **PO/Contract Number** Ρ Data Package, Receiving/Inspection Remarks: Inspection Visual Name/ Date **Required Y/N** Damage Y/N **Comments** Initials Comp. **Process Flow:** Work Name/ Date # Operation **Start Date** Area Instructions Initials Comp. Clean & Vacuum Bake per LHO K7 14 99 1 Clean as Class A Hardware as per E960022. B. Rivera LIGO Vacuum Prep. Form Control Point 2 NA NA Wrap & Tag vacuum clean 3 LHO VBO Load# 53 Scan# \$82499 . RLA B. Rivera

 3
 Wrap & Tag vacuum clean parts per E960022-A
 LHO
 VBO Load#<u>53</u> Scan# <u>082499C.0CA</u>
 B. Rivera

 4
 LHO
 Note: Copy this traveler and give to the DCC
 NA

 END: Go to Traveler associated with next higher assembly processing

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- c.

Special Instructions (Handling/Packaging Constraints, Remarks, etc.) or Notes:

DATE	NAME	DESCRIPTION
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<u>ب</u>	LIGO PROCESS TRA	VELER					C Number: E98 Prepared: 🙁	-00-X 20 - 95
<i>(</i>	Originator		*Cogr	lzant Engineer	E	xt./Phone#	Project	Account Number
15	SRIVERA	Mit	E WIN=		(o) c.	25.33	\mathcal{P} -Lig	507311
	Dwg/Part Number	Rev		Part Description	TEPRES I	a construction and a construction of the	rial Number	Qty
Ñ	2972122	135	sc is=			origination of the origination of the	st, Le 2	13
U	sed In (next higher assembly)	B	SCTOG	PASSEMBI				
		Yendor N	me				ontract Number	
	SENIOR FLEXON	105		an a	P	X 279	<u>Ado</u> :	
Da	ta Package, Receiving/Inspec	tion Remarks	•				<u> </u>	
R	Inspection Visual Required Y/N Damage Y/N		alera e di Sudi Politica interna Pagarita di Angela Pagarita di Angela	Comments		de relative seutori Anna de la contra de Anna de la contra de Anna de la contra de la contra de Anna de la contra de la contra de la contra de la contra de Anna de la contra de Anna de la contra de	Name/ Initials	Date Comp.
	TES NO	NOTICEL BELLOWS NOT COHE	GREY TO PTTEMPT OFF OK	SHILIDGES" ARUGNI. ED TOREHOUS WITH	2 Octasio 4 Sauzut	5 DOE 5	B. RIVERA	8.20.99
Pro	ocess Flow:							<u> </u>
#	Operation	Start Date	Work Area	Tinst	ructions		Name/ Initials	Date Comp.
	Clean & Vacuum Bake per LIGO Vacuum Prep. Form		CHEZHO	per E960022-A			RS CLUER	ぜんせき むとうげん しょうせい ひ悪い シート
2	Control Point	· ·	NA	Review/approve RGA sc	an # <u>0824</u>	99 C.K.F	- AEht	- 9/14/99
3	Wrap & Tag vacuum clean parts per E960022-A	82499	SH(140	per package	· · ·		BRNERA	8.25%
4		· · · · · · · · · · · · · · · · · · ·	CIT	······································				

~X

END: Go to Traveler associated with next higher assembly processing

N.B.: A copy of this traveler must be submitted to the DCC each time the original is shipped with the associated part(s) and when the traveler has been completed.

Note: Copy this traveler and give to the DCC

LIGO Form traveler-01 (5/98)

Page 1 of 2

	E S	190142-01
LIGO PROCESS TRAVELER cial Instructions (Handling/Packaging Constraints, Remarks, etc.) or Notes:	DCC Number: E98_	00-X
(2 LAYERS) (LOUS SAT 1. DAY WRAPPED IN UNIVED (BETORE	BEING WRAPPED IN PLACERISTAT	8:23:45 B-21/2 RA
HN WORDEN HAS LINWRAPPED ENSPECTED AND "HAASS		
THAN ABERANSAS STONE TU PREVENT LEAKS. BRUERO 9.		
NOS VERBALLY OK'D B? DANNIS COTUR TO THE RE-	BACKED AS A LI.H.V. CIEAN	DATES
		· · · ·

Page 2 of 2

DCC Number:

Date Prepared:

E990279-01-X 7/8/99

Michael Smit	<u>1 (- 17)</u>	mator Michael Smith		206	なるななななななるので	lione#	فليحدثه بتحديه غيما	Proje COS	<u>द्ध</u>	Acco Num SF515		
Dwg/Part Number	Rev	Part Description	Serial Number			VBO Load (41			VEO LEGIO 43		VBO Loid 52	
· · · · ·		Beam Dump Assemblies, WBSC2	in a state of the	an farin dan kara a	n na harar a kara a kara sa ka Na kara sa kara	energi yan tahu tike		tu tu en				••••••••••••••••••••••••••••••••••••••
D980087	A	"glass retaining bracket, top left, cavity BD"	012-013	2			2				2	•
D980088	A	"glass retaining bracket, top right, cavity BD"	012-013	2	·		2			-	2	
D980092	A	"glass plate 1, cavity BD"		2	1	·						
D980093	A	"glass plate 2, cavity BD"	-	2						-	· · · ·	
D980289	B	"glass mounting plate1, cavity BD"	012-013	2	i	2						-
D980292	В	"glass mounting plate2, cavity BD"	010-011	2		2	2					
D980296	A	"glass retaining bracket, bottom left, cavity BD"	012-013	2			2	1			2	
0980297	A	"glass retaining bracket, bottom right cavity BD"	012-013	2			2				2	
D980348	В	"side plate, cavity BD"	025-028	4		4						
D980378	В	"Stiffener Block, cavity BD"	013-014	2		2			· · ·			1994 - 19
D980685	A	"clamp, plate beam dump"		8				· · · · · · · · · · · · · · · · · · ·		1		
D990028	A	Beam Dump Flex Hinge Tongue	011-014	4				4		-		
D990029	В	Beam Dump Flex Hinge Clevis	015-017, 019	4	1			4		1 (019)		
D990030	Α	Beam Dump Flex Hinge Tee	013-016	4			3	4	<u> </u>			
D990031	Α	Beam Dump Flex Hinge Saddle	013-015, 010	4			4	3	1			
D990032	A	Beam Dump Flex Hinge Attach	014-017	4			4	4				
D990033	A	Beam Dump Flex Hinge Adapter	018, 015, 011	4		3			. 4	•		
D990140	D	Beam Dump Housing Plate	009, 010	2	}	2		-	<u> </u>			
D990149	C	"Cavity Beam Dump, Mounting Bracket Angle "	010, 012, 014, 015	4			4	4		1		

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LIGO Form traveler-03 (10/16/98)

DCC Number

r:	E990279-01-X

	Dwg/Part Number	Rev	Part Description	isattili Number	QGY	VBO Load 40	VBO Loid 211	VBO Dad 43	NiBor 11570 12570 12670			NiBle Length S2	MBO Lastif 320
	D990150	В	"Cavity Beam Dump, Mounting Bracket Gusset "	013, 014, 016, 017	4			4		4			·
	D990151	В	"Cavity Beam Dump, Mounting Bracket Backplate 1"	009, 015, 019 016	4			4		4			
	D990152	C	"Cavity Beam Dump, Mounting Bracket Backplate 2"	016, 017 010, 012	4			4		4			
	D990198	В	Beam Dump Flex Hinge H_tube	008, 011, 006	4								3
	D990199	A	Beam Dump Flex Hinge Low Strap	012, 014, 016, 017	4				4				
	D990200	A	Beam Dump Flex Hinge Backup	007, 008, 025, 027, 035, 036 019, 032	8			8		8			
	D990201	A	Beam Dump Flex Hinge Cap	030, 032, 038, 035, 018, 028, 031,037	8			8	8	- -			
	D990202	В	Beam Dump Flex Hinge Top Strap	011-014	4			4	4				
	D990207	B	"rail, plate beam dump"	015-018	4			3		4 -	1		
	D990218	B	"glass, plate beam dump"		2					<u> </u>			
1.	D990222	A	Beam Dump Housing Tube 2KBSAR3		0						_	ļ	
	D990223	C	Beam Dump Housing Tube 2KFM		0					<u> </u>			

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DCC Number: E990279-01-X

Dwg/Part Number	Rev	Part Description	is of Serial Number	Quy	VBO Load 2440×	-WBO Lond 41	VEO Lota 45	1VBO Laid 46	Ville Pegita Legita		10:111 10:111 15:1	Miles Ieatil SEF
D990225	D	"Beam Dump Housing Tube 4KITMHR3, 4KITMHR4"	l	0					e marine de la facta de la constante de la constante de la		a senten ina' da Balandi da para propositi	
D990236	В	"backplate_offset, plate beam dump"		0								
D990240	В	"backplate, plate beam dump"		0					1			
D990252	В	"Beam Dump Housing Tube ITMAR1,2KRMHR3"		2								
D990253	A	Extension Tube	004, 005	2			1	<u>.</u>	1(004)			1(005)
D990335	A	"Beam Dump Flex Hinge H_tube, 2KITMXAR4 "		0								in statis
D990336	A	"Beam Dump Flex Hinge H_tube, 2KITMYAR4"		0								
WFV-10		#10 X 0.31 THK FLAT VENTED WASHER		32							1	40
93615A355		#10-24 X 0.75 LOW HD SCS		24	24							-
92196A245		#10-24 X 0.75 SHCS		8	8							
WFV-06		#6 X 0.016 THK FLAT VENTED WASHER	1	8								40
92196A144		#6-32 X .25 SHCS		8	8						<u> </u>	
WFV-08		#8 FLAT VENTED WASHER		68	48							20
92185A194		#8-32 X .50 SHCS		68	68							
91500A194		#8-32 X .500 FHPS		36	36							
91944A450		0.406ID X 0.88OD X 0.25 THK SPHER WASH		16	16							
92141A029		1/4 FLAT WASHER		32	32							
N-2520-A		1/4-20 HEX NUT		16	16							
93615A410		1/4-20 X .500 LOW HEAD SOCKET SCREW	1	16	16		<u> </u>				<u> </u>	
92196A540		1/4-20 X 0.75 SHCS		48	48							
92196A542		1/4-20 X 1.00 SHCS		32	32				· · ·		<u></u>	
C-2016-NA		"1/4-20 X 1.00 SHCS, AG/SS"		40	20		· · · · ·		<u> </u>		1	20
92196A544		1/4-20 X 1.25 SHCS		16	16					·		
C-2820-NA		"1/4-28 X 1.25 SHCS, AG/SS"		24	24	·					T	
91950A031	1	3/8 X 0.063 FLAT WASHER		6	6	:			+		+	
WFV-38		3/8 X0.032 THK FLAT VENTED WASHER		42	42		· · · · ·					
94804A320		3/8-16 HEX NUT		8	8			- 2 0-			1	

LIGO Form traveler-03 (10/16/98)

Cons.

DCC Number:

Date Prepared: 7/8/99

1200

E990279-01-X

Dwg/Part Number	Rev		Part Descrip	ition	Serial Number	Qty	VBO Load 40	VBO Load 41	VBO Load 43	VBO Load 46	VBO Load	VBO Lond So	VBO Lond ISZ
N-3816-A		"3/8-16 HEX N				4	4	^{***••••••••••••••••••••••••••••••••••}		ſ			
TOP-1616- NA		3/8-16 X 1.00 S	OCKT SET SCR	W-OVL PT AG/SS		8	8	·			1211		1894 1997 1997 1997 1997 1997 1997
90585A626		3/8-16 X 1.25 F	LT HD CAP SCI	EW		8	8				1		
92186A626		3/8-16 X 1.25 H	EX HD SCREW	, <u>, , , , , , , , , , , , , , , , , , </u>		16	16			<u> </u>			
C-1620-NA		"3/8-16 X 1,25 !	SHCS, AG/SS"			8	8						<u> </u>
92186A630		3/8-16 X 1.75 H	EX HD SCREW		-	4	4				1		
92196A630		3/8-16 X 1.75 S	HCS			12	12			1	1		
92186A999		3/8-16 X 7.00 H	EX HD SCREW	· · · · · · ·		16	16						
099-966-12- 20x		BERYLLIUM-C	CU GND STRP			8	8						
6032-400	1	Flex Pivot	· · · · · · · · · · · · · · · · · · ·			8							4
		ter assembly):		C Beam dump Installatio	on, top asse	mbly							
Data Package Inspection Required Y/	1	eiving/Inspection Visual Damage Y/N		Comment	ls 🦂					Name/ Initials		Da Coi	
у		I	nspect for breaka	ge during shipment	ray), un tan	,	÷ .				· .	· · · ·	
Process Flow: # Ope	eratio	n Start Di	ate 🕂 Work Are		Instructio	ons				Name/ Initial		Date Comp	
1 Control P	oint	NA	NA				2010 - 10 - 10 - 10 - 10 - 10 - 10 - 10		NA			VA	
2 Clean		6/18	LHO	per LIGO-E960022	l, as applic:	able			B.V	Veaver	-		
3 Vacuum I	Bake	SEE WOLT PAGE	LHO	per LIGO-E960022	2	B.	ZNK	co	<u>K.</u>	lyan	. 5	PAGE	7
4 Wrap and	p and Bag LHO per LIGO-E960022 B. Weaver												

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DCC Number: <u>E990279-01-X</u>

Date Prepared: 7/8/99

/8/99

Operation Control Point	Start I (+2-199 (-28-0 07.06 07.06 07.06	- ትግ	rk Area	VBO Lo VBO Lo VBO Lo VBO Lo VBO Lo VBO Lo Note: at		scan # Co2999C.(CA) scan # CF0299C.(CA) scan # CF2299C.(CA)	K.R SE	cw fraj fraj	Date Comp. 7/28/99 8/10/99 8/10/99 9/14/99
Box for shipment to LHO				No. ALL	Qty per package	Part BEAM DUMP PARTS		UA JEW	2-10/18/7
7 Ship	No.	LHO all	Ship Qt LLO	Othe	beam the bea	Part Description dump parts r, COS servatory (LHO)			
LIGO Form traveler-03 (1	0/16/98)			of this into	indipeston de	eam dump BSC8 Rebmitted to the DCC each time the origination of the boost of the b		an Na Star Na Star	

$\gamma^{A_{2}}$ LIGO PROCESS TRAVELER

DCC Number: E990279-01-X

Attent	tion: Betsy Weave	er, Jonathan Ke	rn, hold clear	r aints, Remarks, ned and baked par	ts for COS assem	ıbly			
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LI	GO Form traveler-03	8 (10/16/98)			Page 6 of 8				

ACTION ITEMS:

DCC Number:

E990279-01-X

Date Prepared:

7/8/99

Table 1:

DATE	NAME	DESCRIPTION
7/20	B. Weaver	S/N 012-013 of parts D980087, D980088, D980296, and D980297 were sent back to Spacecraft Spec. for rework, as we found that they had not been manufactured completely.
7/15	B. Worth	VBOLOND#43-Rejected due to bad scon. Dennis Counce sent all parts from this load (plus some) to be electropolished or etched for better cleaning.
7/23	B.Wesnor	Ports received back from polishing letching companies Recleaned as per Dennis C.'s email (stached).
8/5/19	B. Wesnor	Clevis 18990029 5/n-019 Was sont out for modification as per DCN#: E990273-B/18990029-B. Rec. back-8/4.
9/10/17	B.Weaver	D980348 s/n 027 & 028 Sent to Brockman Mfg. for remark- holes made into Glots to compensate for In obsarance.
10/11/99	B.Wesver	Giving D980398 s/no27 \$ 028 to B. Rivers for vacuum relarke.
	:	

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DCC Number: E990279-01-X

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Table 1:

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DATE	NAME	DESCRIPTION
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	·	
LIGO Form	traveler-03 (10/16/	/98) Page 8 of 8

Dennis Coyne, 12:12 PM 7/22/99 -0700, Re: cleaning

X-POP3-Rcpt: bweaver@apex

Date: Thu, 22 Jul 1999 12:12:31 -0700

From: Dennis Coyne <coyne@ligo.caltech.edu> Organization: Caltech/LIGO

X-Mailer: Mozilla 3.01Gold (Win95; I)

To: Betsy Weaver <weaver_b@ligo.caltech.edu>

CC: Stan Whitcomb <stan@acrux.ligo.caltech.edu>,

Mike Smith <smith@acrux.ligo.caltech.edu>,

Bartie Rivera <rivera_b@ligo-wa.caltech.edu> Subject: Re: cleaning

Betsy,

You should clean as follows (E960022-05 except since the parts are too large to ultrasonically clean, i've tailored the cleaning):

48

LOAD

NBO

1) clean with Liquinox first (solution per E960022-05) and using a rubbing/scrubbing action (i.e. not just rinsing the liquinox over the surfaces). All holes must be cleaned with a brush (stainless steel, phosphor-bronze preferred, but nylon is acceptable). It is ESSENTIAL that the liquinox NOT dry before being rinsed with DI water.

2) Thoroughly rinse with DI water. All surfaces and holes must be rinsed THOROUGHLY.

3) Rinse & rub (with gloved hand only) all surfaces with either methanol or isopropal alcohol. Squirt the solvent into all holes.

4) Blow dry with clean, filtered air or N2, or allow to dry on a clean bench. Do not leave exposed for longer than about 15 minutes, before covering with UHV foil.

With regard to cleaning the lens, please see Stan for a confirmation, but I believe the rule that we operate under is that if all surfaces are polished, then an optics cleaning and wetting test is adequate and no baking is required. However, if the sides of the optic are not polished (as I suspect is the case for the ETM optics), then it should be cleaned and baked and re-cleaned. However, please confirm this with Stan and he may grant a waiver if he examines the surface condition of the optics. Dennis

Betsy Weaver wrote:

> Hi Dennis-

> Two cleaning questions for you:

> 1. We just received the aluminum load (COS) from the etching company.
 > How should we clean them here, before baking them? (They are

Dennis Coyne, 12:12 PM 7/22/99 -0700, Re: cleaning

> obviously too large to put in the ultrasonic cleaner...)

>

> 2. Mike has one large and two small lenses that are going to be

> used in the ETM Telescope Assembly. If they wet well during cleaning,

> do they really need to be baked? A while ago, Stan told me that the

> small steering mirrors for IO and COS did not need to be baked, as the oven

> would just make them dirtier, because they wetted so well during cleaning.

> is this the same for the lenses? If they do need to be baked, can I put

> them in

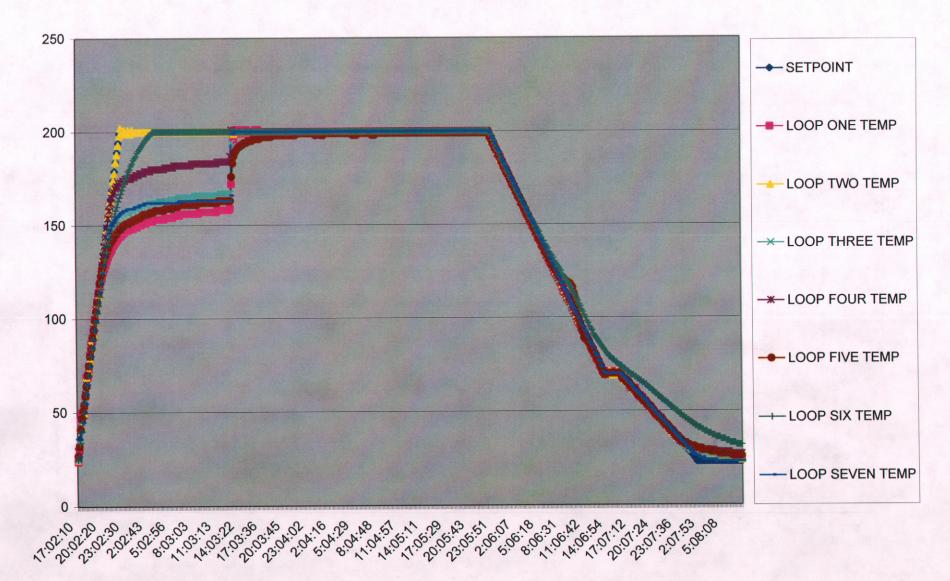
> the next load with the one Large Optic?

>

> Thanks-

> Betsy

Dennis Coyne (Detector Installation Manager) LIGO Laboratory, Caltech, Physics Department 626.395.2034 @CIT / 225.686.3168 @Livingston / 509.372.8166 @Hanford cell 626.695.8350



LHO VACUUM BAKE OVEN A LOAD 53

LHO VACUUM BAKE OVEN A LOAD #53 ELEVATED TEMPERATURE BACKGROUND SCAN

V-1 Closed

No Elevated Temperature Background Data Available

LHO VACUUM BAKE OVEN A LOAD #53 ELEVATED TEMPERATURE SCAN

۰,

V-1 Open, Cal-Gas and V-2 Closed, 70°C

No Elevated Temperature Data Available

LHO Bake Oven A Load # 53

1^{st} Order Desorption Outgassing Rate Estimates using $Q_{tow} = SP_{tow} = SP_{high}[e^{(E_s/kT_{high})]/[e^{(E_s/kT_{tow})]}]$

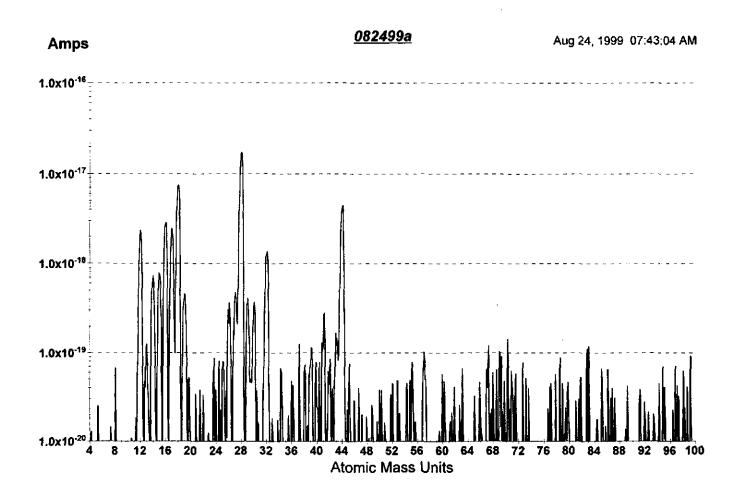
Number of units in bake load	Pump Speed (L/sec)	AMU	RGA background current (amps)	RGA current (amps) @ T _{high}	Calibration Factor CF (torr/amps)	T _{high} (K)	T _{law} (K)	Es/k	Extrapolated outgassing rate (torr*L/sec) @ T _{íow}
1	5	41	No Data	No Data	2.00 E+ 07	No Data	No Data	13000	No Data
1	5	43	No Data	No Data	2.00E+07	No Data	No Data	8000	No Data
1	5	53	No Data	No Data	2.00E+07	No Data	No Data	13000	No Data
1	5	55	No Data	No Data	2.00E+07	No Data	No Data	15000	No Data
1	5	57	No Data	No Data	2.00E+07	No Data	No Data	15000	No Data

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...

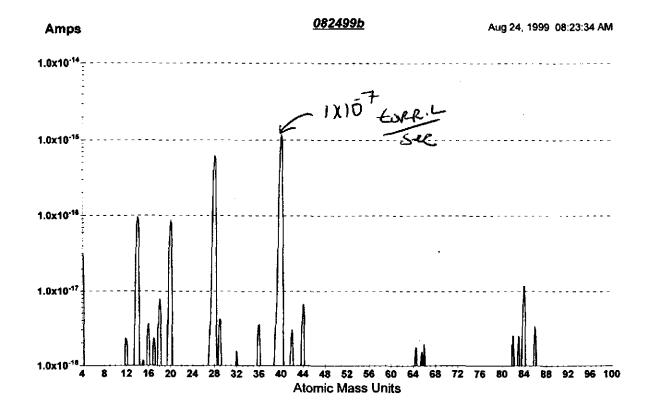
LHO Vacuum Bake Oven A Load #53 RGA Background

V-1 Closed, Room Temp



LHO Vacuum Bake Oven A Load #53 Calibration

V-1 and cal-gas open, V-2 closed in pressure equilibrium at room temperature



CF defined as P_(calc) / I_(meas)

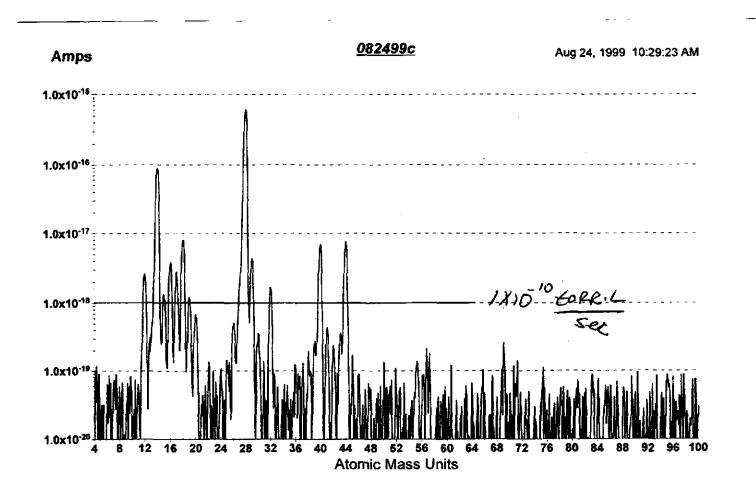
 $P_{calc(40)} = (leak rate) / (pump speed) = (1.1E-7 torr \bullet L/sec)(0.86) / (5 L/sec) = 1.8E-8 torr$

 $I_{(meas)} = 1E-15$ amps

CF = (1.8E-8 torr) / (1E-15 amps) = 2E7 torr/amps

LHO Vacuum Bake Oven A Load #53 Post-Bake Scan Room Temp

V-1 Open, Cal-Gas and V-2 Closed



Stan Whitcomb, 09:30 AM 9/1/99 -0700, Re: e-mail approval for previous scan

X-POP3-Rcpt: brivera@apex X-Sender: stan@127.0.0.1 X-Mailer: QUALCOMM Windows Eudora Light Version 3.0.5 (32) Date: Wed, 01 Sep 1999 09:30:32 -0700 To: "Bartie J. Rivera" <rivera_b@ligo-wa.caltech.edu> From: Stan Whitcomb <stan@ligo.caltech.edu> Subject: Re: e-mail approval for previous scan

Bartie,

I approve tha scan for load 53.

stan

At 08:41 AM 9/1/99 -0700, you wrote:

>Hello Stan,

>

>

>Can I get you to e-mail me an approval for load
>53 (bsc bellows). You had approved them over the
>phone but the traveler has not been signed and they
>are about to be installed and I wanted to attach the
>approval to the back of the traveler. I will re-fax the
>scans to you at LLO.

>

>Thanks

>Bartie

>

>